

High-reliability discrete products and engineering services since 1977

SILICON CONTROLLED RECTIFIERS

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak repetitive off-state voltage ⁽¹⁾			
(T _J = -40 to +125°C, gate open) MCR67-1 MCR67-2 MCR67-3	V _{DRM} V _{RRM}	25 50 100	v
Peak discharge current ⁽²⁾	I _{TM}	750	А
On-state RMS current (180° conduction angles, $T_{c} = 85^{\circ}C$)	I _{T(RMS)}	25	Α
Average on-state current (180° conduction angles, $T_c = 85$ °C)	I _{T(AV)}	16	А
Peak non-repetitive surge current (half-cycle, sine wave, 60Hz, T _j = 125°C)	I _{TSM}	300	А
Circuit fusing consideration (t = 8.3ms)	l ² t	375	A ² s
Forward peak gate current (pulse width $\leq 1.0 \mu s$, T _c = 85°C)	I _{GM}	2.0	Α
Forward peak gate power (pulse width $\leq 1.0 \mu s$, T _c = 85°C)	P _{GM}	20	W
Forward average gate power (t = 8.3ms, T _c = 85°C)	P _{G(AV)}	0.5	W
Operating junction temperature range	TJ	-40 to +125	°C
Storage temperature range	T _{stg}	-40 to +150	°C
Mounting torque	-	8.0	In. lb.

Note 1: V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded. Note 2: Ratings apply for $t_w = 1$ ms.

Note 3: Test conditions: $I_G = 150$ mA, $V_D = rated V_{DRM}$, $I_{TM} = rated value$, $T_J = 125$ °C.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Maximum	Unit
Thermal resistance, junction to case	R _{eJC}	1.5	°C/W
Thermal resistance, junction to ambient	R _{eja}	60	°C/W
Lead solder temperature	т		°C
(lead length 1/8" from case, 10s max)	IL IL	260	C



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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) Characteristic Symbol Min Max Unit Тур **OFF CHARACTERISTICS** Peak forward or reverse blocking current (V_{AK} = Rated V_{DRM} or V_{RRM}, gate open) I_{DRM}, 10 $T_c = 25^{\circ}C$ $I_{\rm RRM}$ μA 2.0 $T_{C} = 125^{\circ}C$ mΑ **ON CHARACTERISTICS** Peak forward on-state voltage* $(I_{TM} = 50A)^{(4)}$ v V_{TM} 1.8 $(I_{TM} = 750A, t_w = 1ms)^{(5)}$ 6.0 --Gate trigger current (continuous dc) I_{GT} mΑ $(V_{AK} = 12V, R_{L} = 100\Omega)$ 2.0 7.0 30 Gate trigger voltage (continuous dc) ٧ V_{GT} $(V_{AK} = 12V, R_{L} = 100\Omega)$ 0.65 1.5 Gate non-trigger voltage v V_{GD} $(V_{AK} = 12V, R_{L} = 100\Omega, T_{J} = 125^{\circ}C)$ 0.2 0.40 _ Holding current \mathbf{I}_{H} mΑ (V_D = 12V, initiating current = 200mA, gate open) 3.0 50 15 Latching current I_{L} mΑ $(V_D = 12V, I_G = 150mA)$ 60 _ _ Gate controlled turn-on time⁽⁶⁾ t_{gt} μs $(V_D = rated V_{DRM}, I_G = 150mA)$ 1.0 _ _ $(I_{TM} = 50A \text{ peak})$ DYNAMIC CHARACTERISTICS Critical rate of rise of off-state voltage dv/dt V/µs (V_D = rated V_{DRM} , gate open, exponential waveform, T_J = 125°C) 10 Critical rate of rise of on-state current⁽⁶⁾ di/dt A/µs $(I_G = 150 \text{mA}, T_J = 125^{\circ}\text{C})$ 100

Note 4: Pulse width \leq 300 μ s, duty cycle \leq 2%.

Note 5: Ratings apply for t_w = 1ms.

Note 6: The gate controlled turn-on time in a crowbar circuit will be influenced by the circuit inductance.

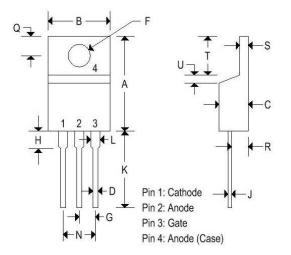


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MECHANICAL CHARACTERISTICS

Case:	ТО-220АВ	
Marking:	Marking: Body painted, alpha-numeric	
Pin out:	See below	

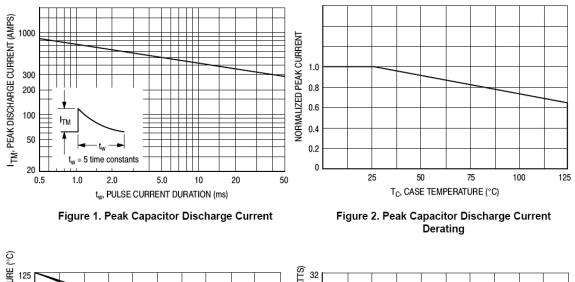


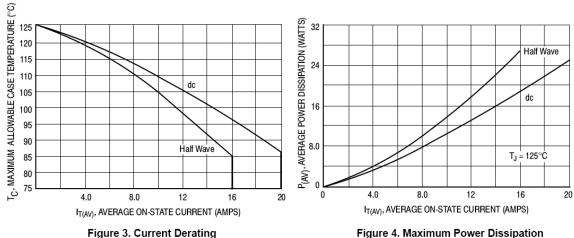
	TO-220AB				
	Inc	Inches		neters	
	Min	Max	Min	Max	
А	0.575	0.620	14.600	15.750	
В	0.380	0.405	9.650	10.290	
С	0.160	0.190	4.060	4.820	
D	0.025	0.035	0.640	0.890	
F	0.142	0.147	3.610	3.730	
G	0.095	0.105	2.410	2.670	
H	0.110	0.155	2.790	3.930	
J	0.014	0.022	0.360	0.560	
Κ	0.500	0.562	12.700	14.270	
L	0.045	0.055	1.140	1.390	
Ν	0.190	0.210	4.830	5.330	
Q	0.100	0.120	2.540	3.040	
R	0.080	0.110	2.040	2.790	
S	0.045	0.055	1.140	1.390	
Τ	0.235	0.255	5.970	6.480	
U		0.050		1.270	
۷	0.045	2 2 0	1.140		
Ζ	-	0.080	14	2.030	



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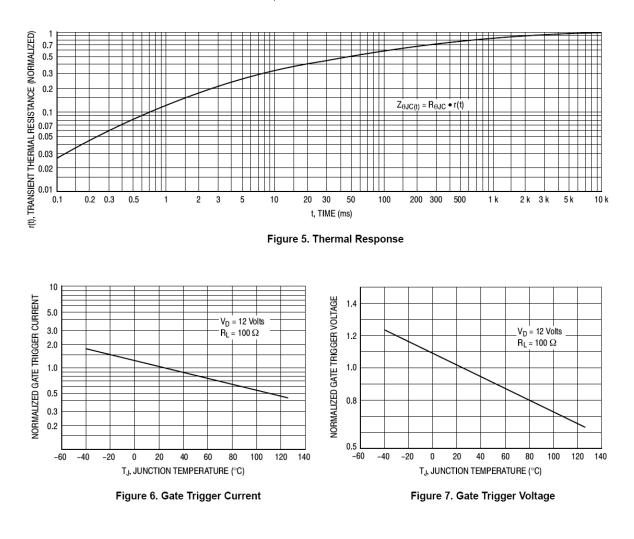






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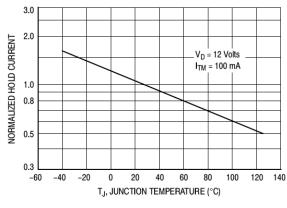


Figure 8. Holding Current